

SESSION SCHEDULE

Monday:

- 8:30 to 11:45 a.m. Congress Welcome & Keynote Address & Energy Efficiency I; Ballroom F-ACC; R. Schiffmann
1:30 to 6:00 p.m. Energy & Energy Efficiency II; Ballroom F-ACC; R. Schiffmann
10:30 a.m. to 4:30 p.m.: Semiconductor and Microelectronics Fabrication; Meeting Room 19A-ACC; J. Booske
1:30 to 5:00 p.m.: Waste Processing and Remediation; Ballroom G-ACC; G. Wicks
5:30 to 7:00 p.m.: Poster Session; Hall 4-ACC; M. Willert-Porada

Tuesday:

- 8:00 a.m. to 2:30 p.m.: MW & RF Applications: Case Histories; Meeting Room 19B-ACC; D. Parent and B. Wilson
8:00 to 11:30 a.m.: Materials Processing – Ceramics I; Ballroom F-ACC; G. Tayler
1:30 to 5:30 p.m.: Materials Processing – Ceramics II; Ballroom F-ACC; R. Kiminami
8:00 to 11:30 a.m.: Materials Processing – Polymers I; Meeting Room 19A-ACC; N. Tran
1:30 to 5:30 p.m.: Materials Processing – Polymers II; Meeting Room 19A-ACC; E. Ripley
8:00 to 11:30 a.m.: Dielectric Property Measurements and Techniques I; Ballroom G-ACC; L. Feher
1:30 to 5:00 p.m.: Dielectric Property Measurements and Techniques II; Ballroom G-ACC; P. Veronesi

Wednesday:

- 8:00 to 10:30 a.m.: Application Economics and Productivity; Meeting Room 19B-ACC; R. Schiffmann and M. Yonnone
8:00 to 11:30 a.m.: Materials Processing – Ceramics III; Ballroom F-ACC; H. Huey
8:00 to 11:30 a.m.: Modeling and Material Interactions I; Meeting Room 19A-ACC; K. Rybakov
1:30 to 5:30 p.m.: Modeling and Material Interactions II; Meeting Room 19A-ACC; S. Bhaduri
8:00 to 11:30 a.m.: Plasma Processing I; Ballroom G-ACC; G. Bond
1:30 to 5:30 p.m.: Plasma Processing II; Ballroom G-ACC; J. Binner
1:30 to 3:30 p.m.: Materials Processing – Glass and Minerals; Ballroom F-ACC; G. Link
10:30 a.m. to 5:00 p.m.: Systems Architecture and Design; Meeting Room 19B-ACC; J. Gerling and S. Morrow
3:30 to 5:30 p.m.: Biochemistry and Biomedical Applications; Ballroom F-ACC; D. Folz

Thursday:

- 8:00 to 11:30 a.m.: Inorganic Chemistry; Meeting Room 19A-ACC; R. Schulz
8:00 to 11:00 a.m.: Organic Chemistry; Ballroom G-ACC; M. Lodaya
8:00 to 11:00 a.m.: Metals/Metal Powder Processing; Ballroom F-ACC; D. Agrawal